

Exam Question Solutions May 2012

Q1 Charge neutrality condition

(a) $n + N_a = p + N_d$
 also $np = n_i^2 = p_i^2$

$$\therefore \frac{p_i^2}{p} + N_a = p + N_d$$

$$p^2 - (N_a - N_d)p - p_i^2 = 0$$

$$p = \frac{N_a - N_d}{2} + \frac{N_a - N_d}{2} \left[1 + \left(\frac{2p_i}{N_a - N_d} \right)^2 \right]^{1/2}$$

i) For P-type $N_a - N_d \gg p_i$

$$\therefore p = N_a - N_d = N_a$$

$$n = \frac{p_i^2}{p} = \frac{p_i^2}{N_a - N_d} = \frac{p_i^2}{N_a} \left(= \frac{n_i^2}{N_a} \right) \quad [2]$$

Some people did it for n-type rather than p-type

ii) for compensation near intrinsic $p_i \gg N_a - N_d$

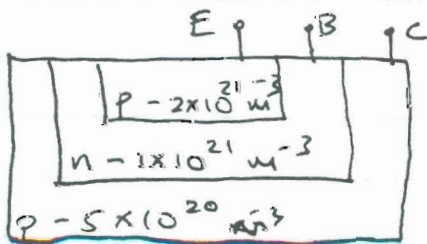
$$p = \frac{N_a - N_d}{2} + \frac{N_a - N_d}{2} \left[\frac{2p_i}{N_a - N_d} \right] \approx p_i$$

$$n = \frac{p_i^2}{p} = p_i \left(= n_i \right) \quad [2]$$

(b) Starting with $N_a = 5 \times 10^{20}$ i.e. p-type semiconductor
 1st diffusion has to be $> 5 \times 10^{20} \text{ cm}^{-3}$ but opposite doping type (n-type)

2nd diffusion has to be $>$ 1st diffusion and p-type

So from choices given 1st diffusion is $1 \times 10^{21} \text{ m}^{-3}$ with donors and 2nd diffusion is $2 \times 10^{21} \text{ m}^{-3}$ with acceptors [4]



This is a p-n-p transistor
 Many people tried to do a n-type base and got confused [2]

(c) From (a)

$$p = \frac{N_a - N_d}{2} \left[1 \pm \sqrt{1 + \left(\frac{2p_i}{N_a - N_d} \right)^2} \right]$$

In this semiconductor $|N_d - N_a| \ll n_i$ ($\approx p_i$), so

$$p_{\text{collector}} = 5 \times 10^{20} \text{ m}^{-3}$$

$$n_{\text{base}} = 10^{21} - 5 \times 10^{20} = 5 \times 10^{20} \text{ m}^{-3}$$

$$p_{\text{emitter}} = 2 \times 10^{21} + 5 \times 10^{20} - 1 \times 10^{21} = 1.5 \times 10^{21} \text{ m}^{-3}$$

Relatively few got this simple section fully correct

minority carrier concentration ~~are~~ in the emitter is

$$n_{\text{emitter}} = \frac{(1.3 \times 10^{16})^2}{1.5 \times 10^{21}} = 1.12 \times 10^{11} \text{ m}^{-3}$$

[7]

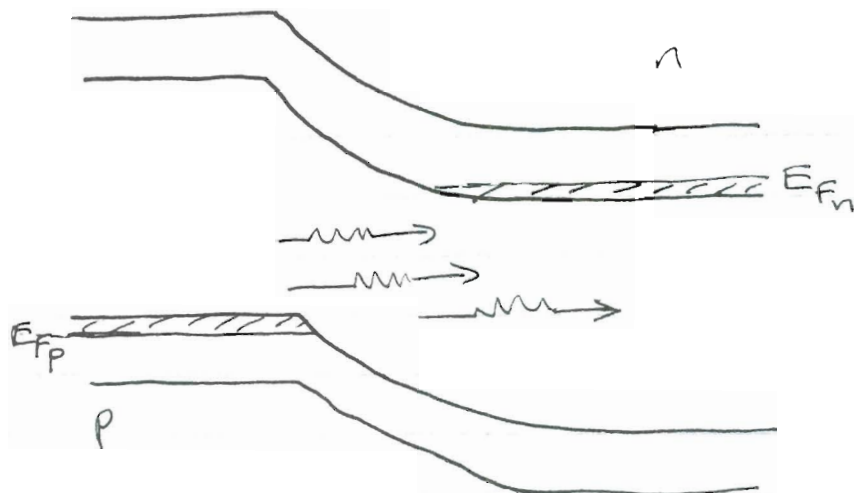
- (d) As the temperature increases, the n_i value increases and the minority carrier concentrations increase making the minority leakage currents in the transistor larger. At high temperatures, the semiconductor can appear to be intrinsic

You can increase the maximum operating temperature by increasing the doping levels in the transistor.

[3]

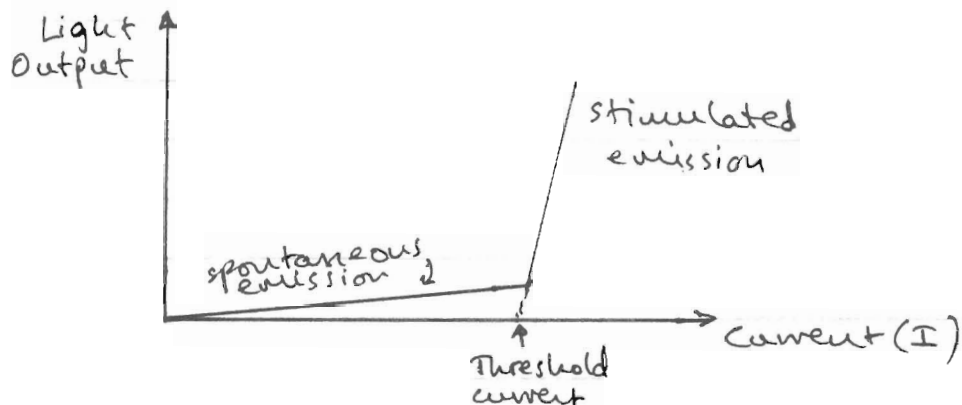
Most people got (d) correct

2 (a)



Heavily doped p and n doped regions and forward bias. Electrons and holes diffuse across the depletion region and recombine hence photons are emitted. Fermi levels move apart as shown.

The difference between the Fermi levels is the voltage under forward bias and population inversion can occur and stimulated emission occurs. High reflectors are needed to form a cavity which reflects the photons and determines the exact lasing wavelength.



[6]

Most people did well in part (a)

(b) Maximum wavelength given by $\frac{1.24}{1.8 \text{ eV}} = 0.688 \mu\text{m}$

Minimum wavelength given by $\frac{1.24}{2.4 \text{ eV}} = 0.516 \mu\text{m}$

InGaP is the QW material (narrower band gap) and InAlP is the barrier material (wider band gap).

No problems with (b) - some did not get the QW material correctly identified.

[4]

- c. We wish to have emission at $650\text{nm} \equiv 1.907\text{eV}$. This is an increase in energy over InGaP of $1.907 - 1.8 = 107\text{meV}$.

Using the expression for the 1st bound energy levels for electrons and holes:

$$\frac{h^2}{8m_e^*m_0L^2} + \frac{h^2}{8m_h^*m_0L^2} = 107\text{meV}$$

$$\frac{h^2}{8m_0L^2} \left(\frac{1}{m_e^*} + \frac{1}{m_h^*} \right) = 107\text{meV}$$

$$\therefore L^2 = \frac{h^2 \left(\frac{1}{m_e^*} + \frac{1}{m_h^*} \right)}{8m_0 \times 107 \times 10^{-3} \times 1.6 \times 10^{-19}}$$

$$= 3.518 \times 10^{-18} \times 12.54 = 4.412 \times 10^{-17}$$

$$\Rightarrow L = 6.64\text{nm}$$

[5]

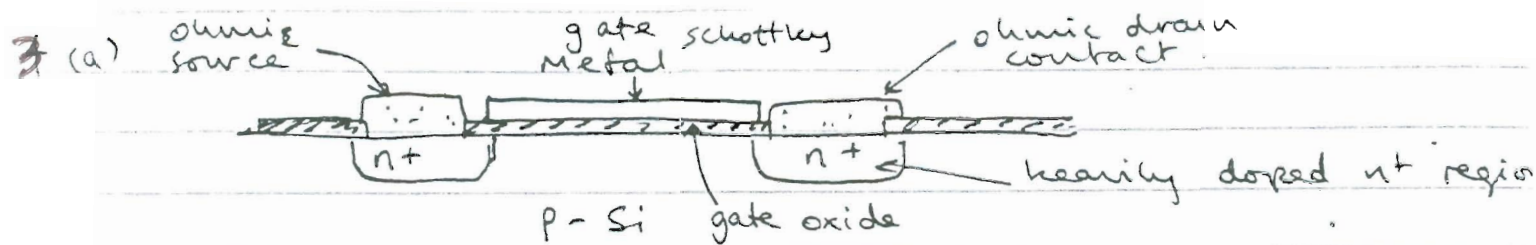
Many people got this correct - some forgot the e^- so had a huge error

There is an uncertainty of $\pm 0.5\text{nm}$. This affects the 1st bound level energy as:

$$\Delta E \propto \frac{1}{(L \pm 0.5\text{nm})^2}$$

The accuracy of the emitted wavelength would therefore be higher in structure with a large L as the effect of the $\pm 0.5\text{nm}$ would be relatively small. The opposite is true in smaller L structures and the $\pm 0.5\text{nm}$ would result in a poorer accuracy. Several people [3] calculated this - a description would have sufficed.

- d. At short wavelengths, when L becomes small, the height of the barrier material and tunnelling will affect the shortest wavelength that can be achieved. Quite a few got (d) incorrect despite mentioning [2] tunnelling.



A few did not show the gate edge over the n^+ channel properly [3]

(b) Saturation occurs when $V_d = V_g - V_t$
The drain current is then given by

$$I_{ds} = \frac{\mu_e C_g}{l^2} \frac{V_d^2}{2}$$

Transconductance, $g_m = \left. \frac{\partial I_d}{\partial V_g} \right|_{V_d}$ in saturation region

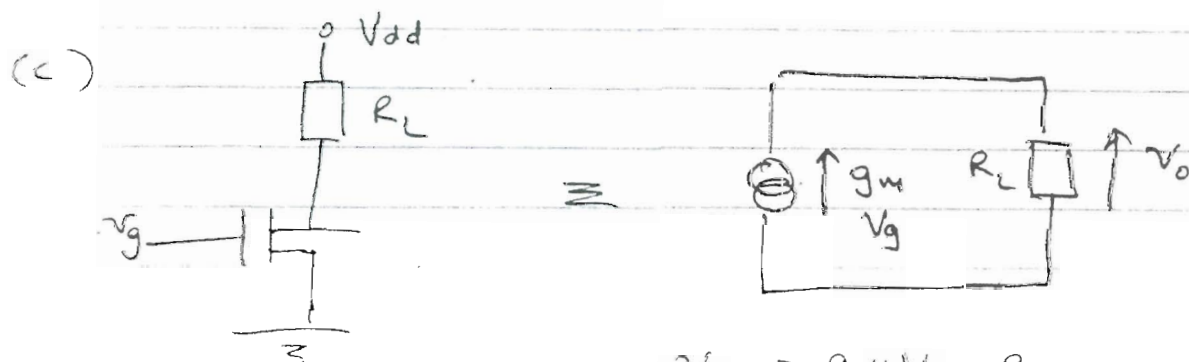
$$\text{So } g_m = \frac{\mu_e C_g}{l^2} V_d \quad [3]$$

By substituting into above eqns

$$\frac{\mu_e C_g}{l^2} = \frac{g_m}{V_d} = \frac{2 I_{ds}}{V_d^2}$$

$$\text{so } g_m = \frac{2 I_{ds}}{V_d} \quad [2]$$

Fairly straightforward



$$v_o = g_m V_g \cdot R_L \quad [3]$$

$$\text{Gain} = \frac{v_o}{V_g} = |A| = \frac{g_m \cdot R_L}{\cancel{V_g}} \quad [2]$$

3 cont. $\therefore 30 = g_m R_L = \frac{2I_{ds}}{V_d} \cdot R_L = \frac{2I_{ds} R_L}{(V_{dd} - I_{ds} R_L)}$

$$30 = \frac{2 \cdot 30 \times 10^{-3} R_L}{100 - 30 \times 10^{-3} R_L}$$

gives $R_L = 3.125 \text{ k}\Omega$

2

Very few got this completely correct - seemed to confuse V_d and 100V supply.

cd

$$V_d = 100 - 30 \times 10^{-3} \cdot 3.125 \text{ k}\Omega = 6.25 \text{ V}$$

$$g_m = \frac{2 \cdot I_{ds}}{V_d} = \frac{2 \times 30 \times 10^{-3}}{6.25} = 9.6 \text{ mS}$$

Since g_m also = $\frac{\mu_e C_g V_d}{l^2}$

$$l^2 = \frac{\mu_e C_g V_d}{g_m} = \frac{0.13 \times 10^{-12} \times 6.25}{9.6 \times 10^{-3}}$$

$$l = 9.2 \mu\text{m} \quad (\text{gate length})$$

$$C_g = \frac{\epsilon_0 \epsilon_r \text{Area}}{t_o} = \frac{\epsilon_0 \epsilon_r l \cdot \text{width}}{t_o}$$

length = 0.1 width \Rightarrow width = $92 \mu\text{m}$

$$t_o = \frac{\epsilon_0 \epsilon_r l \cdot \text{width}}{C_g} = \frac{11.8 \times 8.85 \times 10^{-12} \times 9.2 \mu\text{m} \times 92}{10^{-12}}$$

$$t_o = 88 \text{ nm}$$

Very few managed to do this correctly

[5]

Q4 An electron travelling in a vacuum has energy E ,
 (a) $E = \frac{1}{2} m v^2 = \frac{p^2}{2m}$ (as momentum $p = mv$)

Differentiating this twice gives:

$$\frac{dE}{dp} = \frac{p}{m}, \quad \frac{d^2E}{dp^2} = \frac{1}{m}$$

In a semiconductor, replace m with an 'effective' mass, m^* to account for lattice interactions

$$m^* = \left(\frac{d^2E}{dp^2} \right)^{-1}$$

[4]

Most managed this with few problems.

(b) $E-k$ relationship is assumed parabolic, so:
 $E = A + Bk^2$, where A, B are constants

Bandgap at $k=0$ for direct band-gap semiconductor, so
 $\Rightarrow A = 1.8 \text{ eV}$

$$\frac{dE}{dk} = 0 + 2Bk, \quad \frac{d^2E}{dk^2} = 2B, \quad \hbar^2 \frac{d^2E}{dp^2} = 2B \quad (p = \hbar k)$$

$$\therefore m^* = \frac{\hbar^2}{2B} = 0.09 \times 9.11 \times 10^{-31}$$

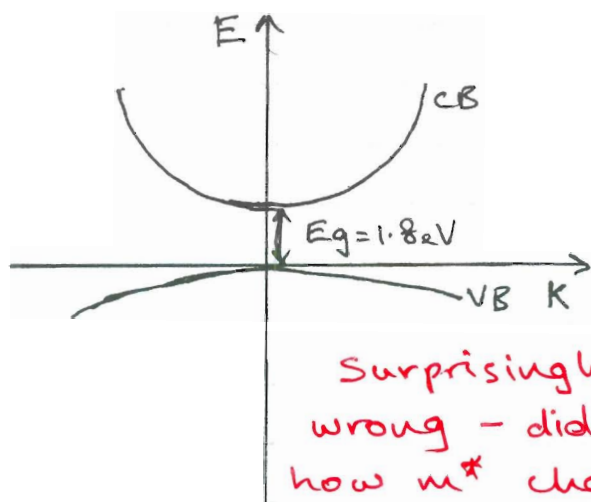
$$B = \left(\frac{6.626 \times 10^{-34}}{2\pi} \right)^2 \times \frac{1}{2} \times \frac{1}{0.09 \times 9.11 \times 10^{-31}} = 0.68 \times 10^{-37} \text{ J m}^2$$

$$= 4.25 \times 10^{-19} \text{ eV}$$

$$E = 1.8 + 4.25 \times 10^{-19} k^2 \text{ eV}$$

Most got this approximately correct - some did not give units or mixed eV and J m^2 together

4 b.
cont.



The 8x higher mass for holes results in a much 'flatter' VB structure

Surprisingly many got this wrong - did not seem to know how m^* changed with $E-K$

In reality, the electron effective mass increases as you approach the Brillouin zone edge. The CB energy does not continue to increase at the same rate as you move away from $K=0$ and eventually becomes constant (electron velocity = 0)

Relatively few got how m^* changes correct - several gave the opposite answer [6]

c Heisenberg Uncertainty Principle

$$\Delta p \Delta x \geq \hbar/2$$

This implies that both parameters of a particle, i.e. the momentum and position, cannot be measured simultaneously to an arbitrary high degree of precision.

Quite a few got the exact form wrong, confusing h, \hbar etc. [4]

d. de Broglie: $p = mv = \frac{h}{\lambda}$ where h = Planck's const

$$\lambda = \frac{h}{mv}$$

This was apparently easy

The P.E. of electron = K.E.

$$\frac{1}{2}mv^2 = eV$$

$$4. \quad \Rightarrow v = \left(\frac{2eV}{m} \right)^{1/2}$$

$$\text{so } \lambda = \frac{h}{(2eVm)^{1/2}} = \frac{1.225 \text{ nm}}{V^{1/2}}$$

when $V = 50 \text{ V}$, $\lambda = 0.17 \text{ nm}$ so this is the minimum feature size

Relatively few got the correct numerical answer
- despite this being a tutorial type question